

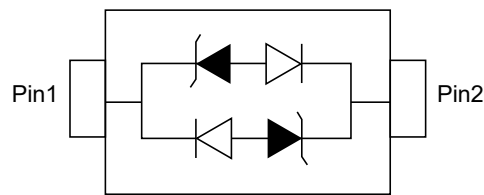
## 1.Features

- IEC 61000-4-2(ESD)±15KV(air), ±8KV(contact)
- 150Watts peak pulse power (tp=8/20µS)
- Ultra low capacitance: 1.5pF maximum
- Low clamping voltage
- Weight 5.0 mg

## 2.Applications

- Ethernet

## 3.Pinning information



**SOD-323**

## 4.Part Number and Electrical Parameter

Part Number	$I_{DRM}@V_{DRM}$		$V_{BR}^{①}@I_R$		$V_C@I_{PP}^{②}$		$V_C@I_{PP}^{②}$		$C_o^{③}$	
	µA	V	V	mA	V	A	V	A	pF	pF
	MAX		MIN		MAX		MAX		TYP	MAX
BV03CW	0.5	3	3.5	1	5.8	1	15	10	0.85	1.5

Notes:

Absolute maximum ratings measured at T= 25°C RH=45%-75% (unless otherwise noted).

①  $V_{BR}$  is measured at  $I_R=1mA$ .

② Surge Waveform: 8/20µs.

③ Off-state capacitance is measured in  $V_{DC}=0V, V_{RMS}=1V, f=1MHz$ .



## 5. Thermal Considerations

Parameter	Symbol	Value	Units
Junction Temperature Range	$T_J$	-55 to 150	$^{\circ}\text{C}$
Storage Temperature Range	$T_S$	-55 to 150	$^{\circ}\text{C}$

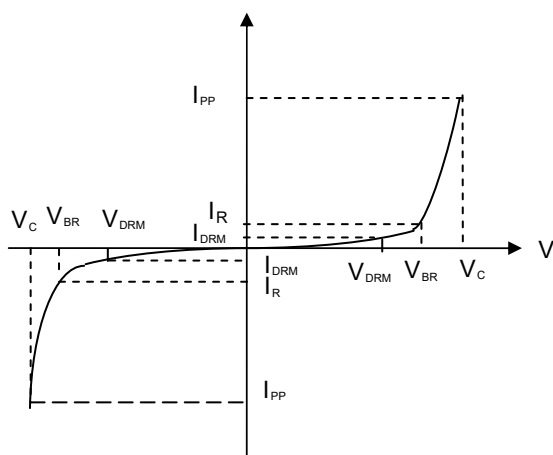
## 6. Environmental Characteristics

Parameter	Technical standards
High Temperature Reverse Bias Test	Temperature: $150 \pm 3^{\circ}\text{C}$ Bias=80%, $V_{\text{DRM}}$ Time:168H
High Temperature Life Test	Temperature: $150^{\circ}\text{C}$ , Time:168H
High-low Temperature Cycle Test	Temperature: From $-40^{\circ}\text{C}$ , to $125^{\circ}\text{C}$ , Dwell time : 30min, 10cycles
High Temperature & High Humidity Test	Temperature: $85^{\circ}\text{C}$ Humidity:85%, Time:168H
Pressure Cooker Test	Temperature: $121^{\circ}\text{C}$ , 2atm. Humidity:100% , Time:24H
Resistance of Soldering Heat	Temperature: $260 \pm 5^{\circ}\text{C}$ , Time of dip soldering: 10s, 3times

Notes:

The above testing items can be specified by customer's special request.

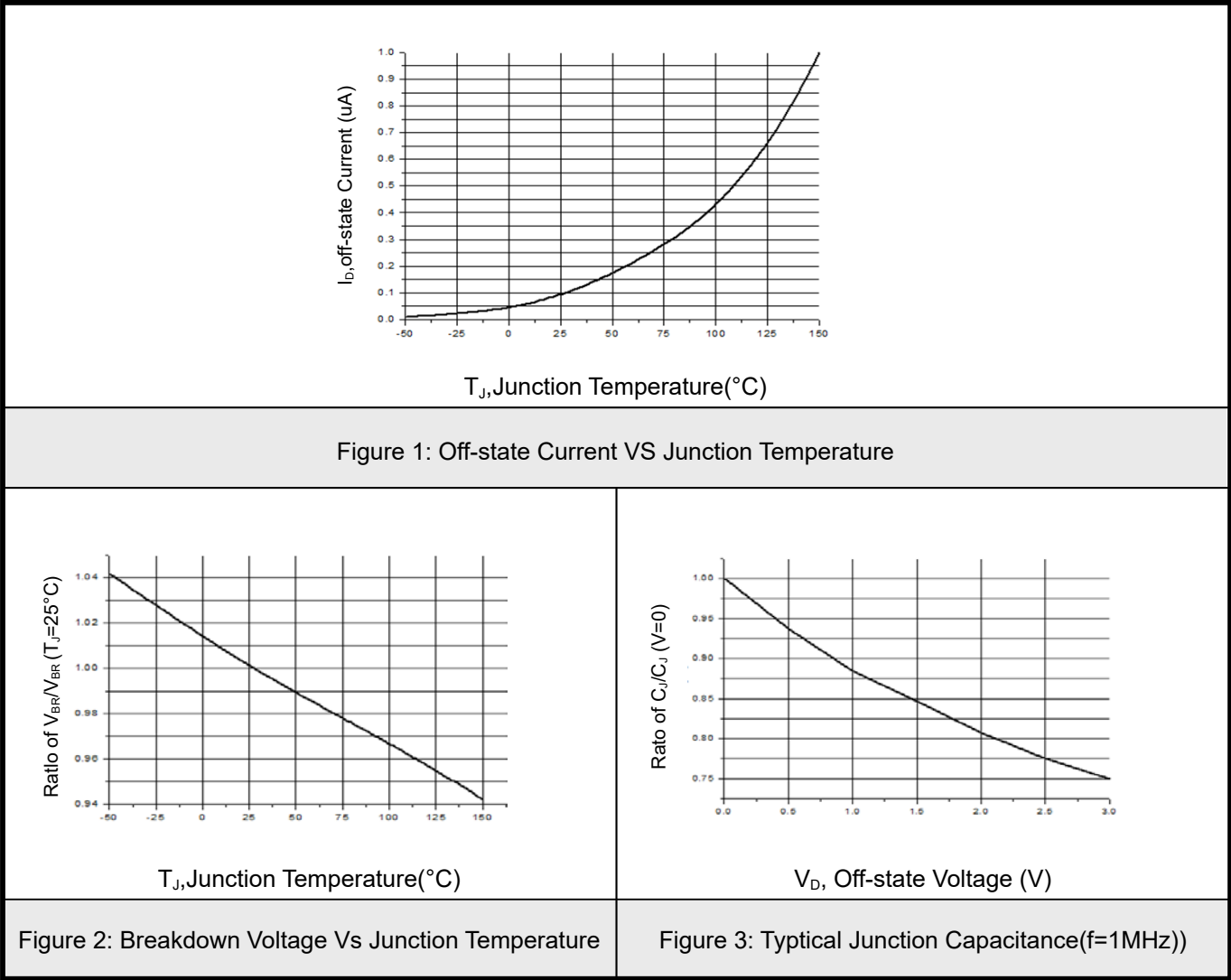
## 7. Electrical Parameters ( $T_A = 25^{\circ}\text{C}$ unless otherwise noted )



Symbol	Parameter
$V_C$	Clamping Voltage
$I_{PP}$	Surge Waveform 8/20 $\mu\text{s}$
$V_{\text{DRM}}$	Stand-off Voltage
$V_{\text{BR}}$	Breakdown Voltage
$I_{\text{DRM}}$	Reverse Leakage Current
$I_R$	Test Current
$P_{PP}$	Peak Pulse Power Dissipation

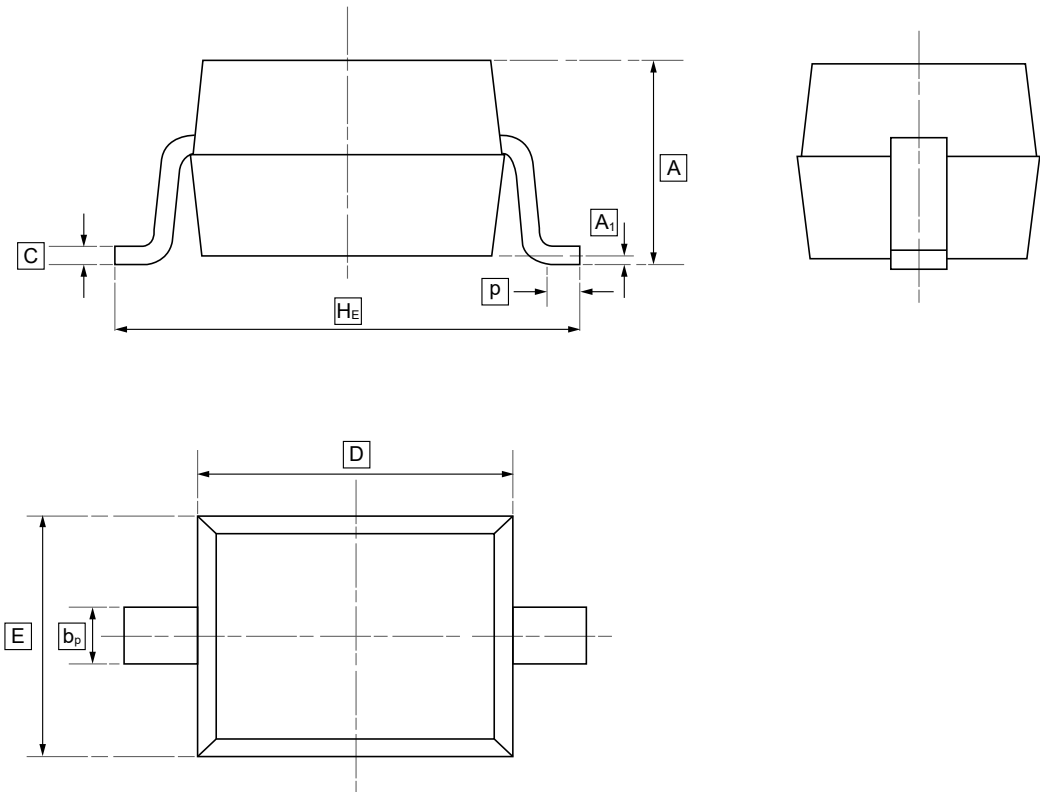


8. Typical characteristic





9.SOD-323 Package Outline Dimensions



DIMENSIONS (mm are the original dimensions)

Symbol	A	bp	C	D	E	HE	A <sub>1</sub>	P
Min	0.90	0.25	0.10	1.60	1.15	2.30	0.01	0.20
Max	1.20	0.40	0.15	1.80	1.35	2.80	0.10	0.50



10.Ordering information



Order Code	Package	Base QTY	Delivery Mode
UMW BV03CW	SOD-323	3000	Tape and reel



## 11.Disclaimer

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